

SSC8019GS6

P-Channel Enhancement Mode MOSFET

> Features

V _{DS}	V_{GS}	R _{DS(ON)} Typ.	l _D
-16V	±12V	19mΩ@-4V5	-7A
		24mΩ@-2V5	-77

> Description

This device is produced with high cell density DMOS trench technology, which is especially used to minimize on-state resistance. This device particularly suits low voltage applications such as portable equipment, power management and other battery powered circuits, and low in-line power dissipation are needed in a very small outline surface mount package.

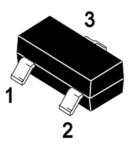
Applications

- Load Switch
- Portable Devices
- DCDC Conversion

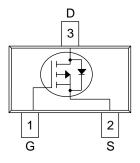
> Ordering Information

Device	Package	Shipping
SSC8019GS6	SOT-23	3000/Reel

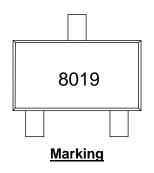
Pin configuration



SOT-23



Pin Configuration (Top View)





➤ Absolute Maximum Ratings (T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V _{DSS}	Drain-to-Source Voltage	-16	V
V _{GSS}	Gate-to-Source Voltage	±12	V
I _D	Continuous Drain Current ^a	-7	Α
I _{DM}	Pulsed Drain Current ^b	-22	А
P _D	Power Dissipation ^c	1.5	W
P _{DSM}	Power Dissipation ^a	0.66	W
TJ	Operation junction temperature	-55~150	$^{\circ}$
T _{STG}	Storage temperature range	Storage temperature range -55~150	

➤ Thermal Resistance Ratings (T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit	
R _{θJA}	Junction-to-Ambient Thermal Resistance a	190	°C AA/	
Rejc	Junction-to-Case Thermal Resistance	82	- °C/W	

Note:

- a. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with T_A=25°C. The value in any given application depends on the user is specific board design. The power dissipation is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on $T_{J(MAX)}$ =150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.

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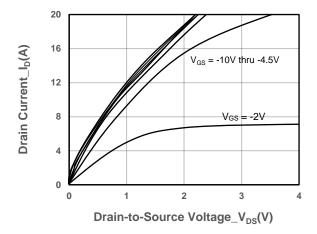


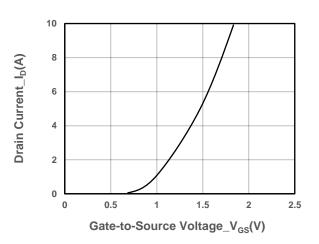
\succ Electrical Characteristics (T_A=25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = -250μA	-16			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{D} = -250uA$	-0.4	-0.6	-1	V
Drain Course On Registeres	R _{DS(on)}	V _{GS} = -4.5V, I _D = -4A		19	25	- mΩ
Drain-Source On-Resistance		V _{GS} = -2.5V, I _D = -3A		24	31	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -12V, V _{GS} = 0V			-1	μA
Gate-Source Leak Current	Igss	$V_{GS} = \pm 12V, V_{DS} = 0V$			±100	nA
Forward Voltage	V _{SD}	V _{GS} = 0V, I _S = -1A		-0.77	-1.3	V
Input Capacitance	Ciss	10/11/		1800		pF
Output Capacitance	Coss	$V_{DS} = -10V$, $V_{GS} = 0V$, $f = 1MHz$		190		
Reverse Transfer Capacitance	Crss	T = TIVIMZ		170		
Turn-on Delay Time	T _{D(ON)}			31		
Rise Time	Tr	$V_{DS} = -10V$, $V_{GS} = -4.5V$,		27		ns
Turn-off Delay Time	T _{D(OFF)}	$R_{GEN} = 3\Omega$, $I_D = -1A$		125		
Fall Time	Tf			83		
Total Gate Charge	Q _G	45777		16		
Gate to Source Charge	Q _{GS}	$V_{GS} = -4.5V, V_{DS} = -10V,$		3		nC
Gate to Drain Charge	Q _{GD}	$I_D = -4A$		4		



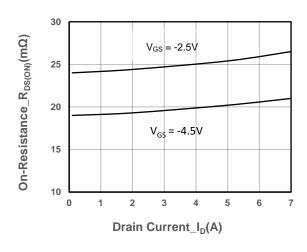
> Typical Performance Characteristics (T_A=25℃ unless otherwise noted)

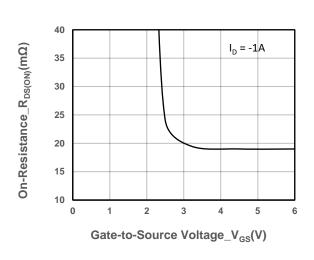




Output Characteristics

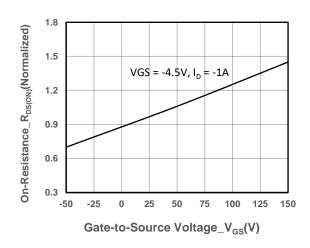
Transfer Characteristics

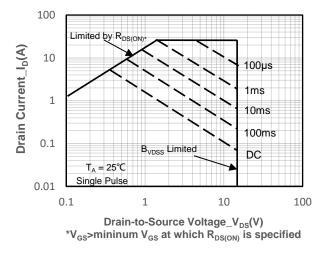




On-Resistance vs. Drain Current and Gate Voltag

On-Resistance vs. Gate-to-Source Voltage



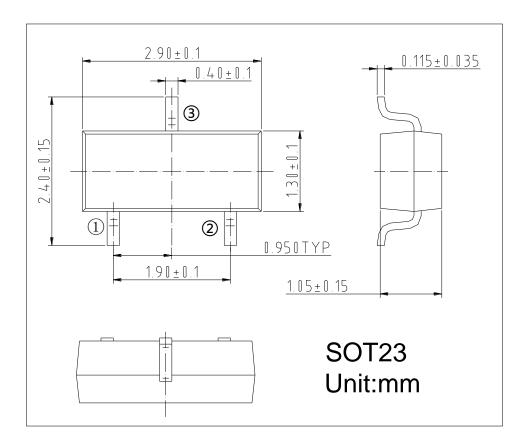


On-Resistance vs. Junction Temperature

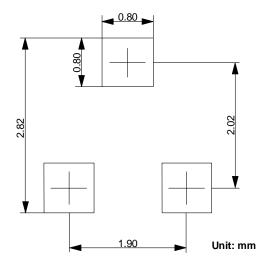
Safe Operating Area vs. Junction-to-Ambient



Package Information



> Recommended Pad outline





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